

# MD1803DFH

High voltage NPN Power transistor for standard definition CRT display

## Features

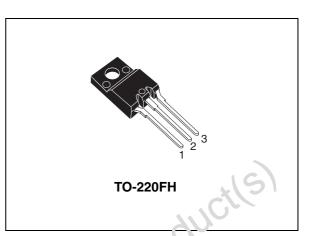
- State-of-the-art technology:
  - Diffused collector "enhanced generation"
- Stable performance versus operating temperature variation
- Low base drive requirement
- Tight h<sub>FE</sub> range at operating collector current
- Fully insulated power package U.L. compliant
- Integrated free wheeling diode

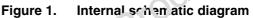
# Applications

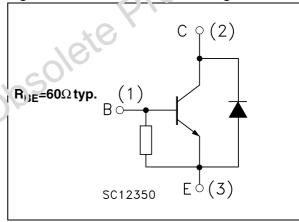
Horizontal deflection output for TV

# Description

The MD1803DFH is manufactured using Diffused Collector in Planar Technology adopting new and enhanced high voltage structure. The new MD product series show improved silicon efficiency bringing updated performance to the Horizontal Deflection stage.







Deflection	stage.	
		Ċ
		2110
	-	0,0
	0	0
	X	•
	XO	
Table 1	<b>Device</b> sum	mary

Grder code	Marking	Package	Packing
MD1803DFH	MD1803DFH	TO-220FH	TUBE

# Content

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#### **Electrical ratings** 1

Symbol	Parameter	Value	Unit
$V_{CES}$	Collector-emitter voltage (V <sub>BE</sub> = 0)	1500	V
V <sub>CEO</sub>	Collector-emitter voltage ( $I_B = 0$ )	700	V
$V_{\text{EBO}}$	Emitter-base voltage (I <sub>C</sub> = 0)	10	V
Ι <sub>C</sub>	Collector current	10	Α
I <sub>CM</sub>	Collector peak current (t <sub>P</sub> < 5ms)	15	Α
Ι <sub>Β</sub>	Base current	5	Α
P <sub>TOT</sub>	Total dissipation at $T_c = 25^{\circ}C$	40	W
V <sub>isol</sub>	Insulation withstand voltage (rms) from all three leads to external heatsink	2500	v
T <sub>stg</sub>	Storage temperature	-65 to 150	°C
ТJ	Max. operating junction temperature	150	U
Table 3.	Thermal data	000	

#### Thermal data Table 3.

	Symbol	Parameter	10	Value	Unit
	R <sub>thj-case</sub>	Thermal resistance junction-case	Max	3.125	°C/W
obsole		roduct(s) - Ob	S	3.129	C/W
0.					



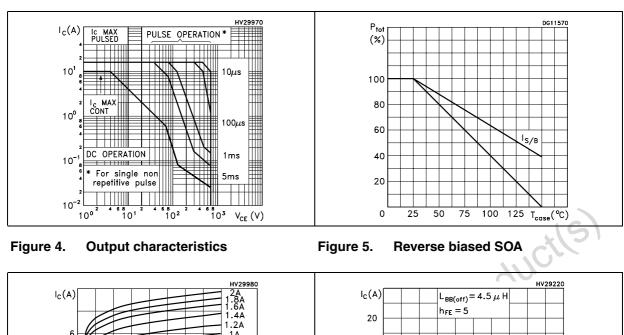
#### 2 **Electrical characteristics**

( $T_{CASE} = 25^{\circ}C$ ; unless otherwise specified)

	Parameter	Test cor	ditions	Min.	Тур.	Max.	ι
I <sub>CES</sub>	Collector cut-off current (V <sub>BE</sub> = 0)	V <sub>CE</sub> = 1500V V <sub>CE</sub> = 1500V	T <sub>c</sub> = 125°C			0.2 2	
I <sub>EBO</sub>	Emitter cut-off current $(I_{C} = 0)$	V <sub>EB</sub> = 5V		40		120	
V <sub>(BR)EBO</sub>	Emitter-base breakdown voltage $(I_C = 0)$	l <sub>E</sub> = 700 mA		10			
V <sub>CE(sat)</sub> <sup>(1)</sup>	Collector-emitter saturation voltage	I <sub>C</sub> = 5 A	I <sub>B</sub> = 1.25 A			2	
V <sub>BE(sat)</sub> <sup>(1)</sup>	Base-emitter saturation voltage	I <sub>C</sub> = 5 A	I <sub>B</sub> = 1.25 A			1.2	5
h <sub>FE</sub> <sup>(1)</sup>	DC current gain	$I_{C} = 1 A$ $I_{C} = 5 A$ $I_{C} = 5 A$	V <sub>CE</sub> = 5 V V <sub>CE</sub> = 1 V V <sub>CE</sub> = 5 V	5.5	18 5	7.5	1
V <sub>f</sub>	Diode forward voltage	I <sub>F</sub> = 5 A	-	2		1.6	
t <sub>s</sub>	Inductive load Storage time	$I_{C} = 4A$ $I_{B(on)} = 0.6A$	$f_h = 16 KHz$ $V_{BE(off)} = -2.7V$		2.5	3	
t <sub>f</sub> I. Pulsed du	Fall time aration = 300 ms, duty cycle £ 1.5%.	$L_{BB(off)} = 4.5 \mu H$	5010		0.3	0.6	
t <sub>f</sub> I. Pulsed du		Ň	5010		0.3	0.6	

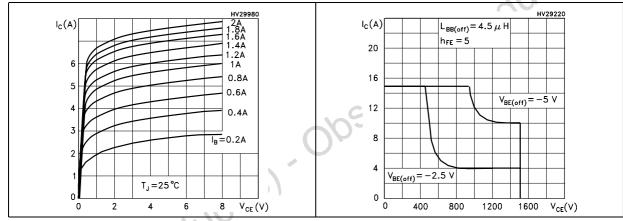
Table 4. **Electrical characteristics** 

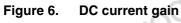
### 2.1 Electrical characteristics (curve)

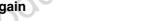


#### Figure 2. Safe operating area

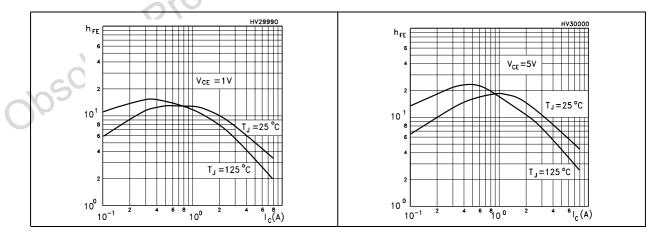
Figure 3. Derating curve









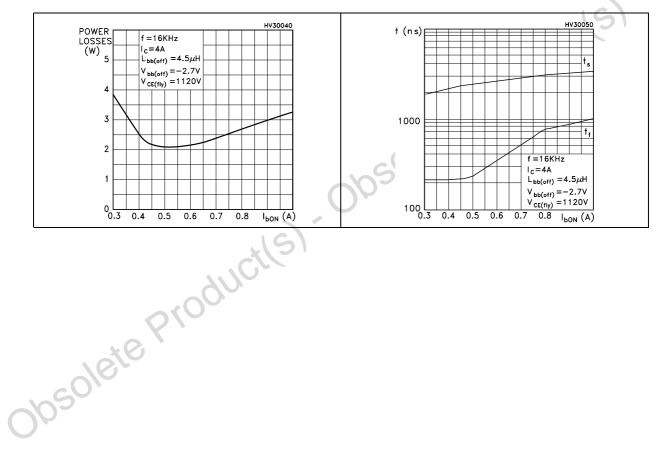


#### HV30030 V<sub>BE (sat)</sub> (V) V<sub>CE(sat)</sub> (V) $h_{FE} = 4$ 1.0 T<sub>J</sub> =125 °C $h_{FE} = 4$ 10 <sup>0</sup> 0.9 T<sub>J</sub> =25 °C 0.8 0.7 10<sup>-1</sup> T<sub>J</sub> =125 °C 0.6 25 °C 10<sup>-2</sup> <u>ا 0.5</u> 0.1 0.2 0.5 2 3 5 I<sub>c</sub> (A) 10<sup>0</sup> 1 $I_{c}(A)$

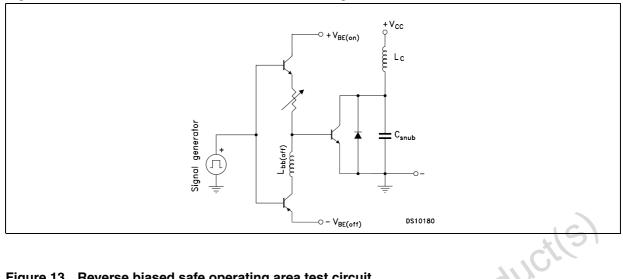
### Figure 8. Collector-emitter saturation voltage Figure 9. Base-emitter saturation voltage



Figure 11. Inductive load switching time

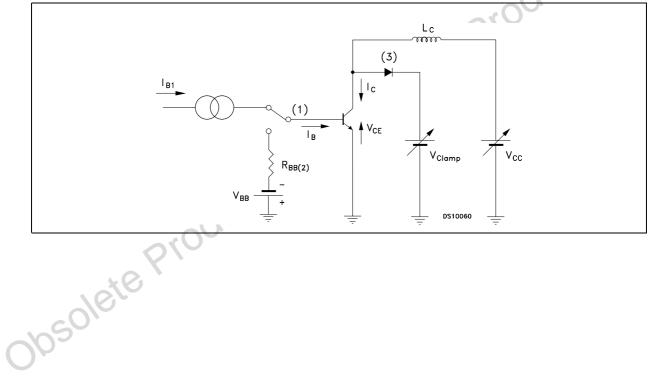


#### **Test circuit** 3



### Figure 12. Power losses and inductive load switching test circuit

#### Figure 13. Reverse biased safe operating area test circuit





# 4 Package mechanical data

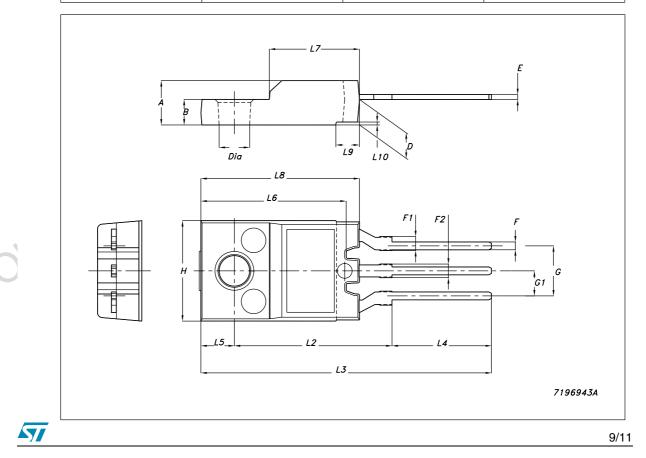
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obsolete Product(s). Obsolete Product(s)



Dim		mm	
	Min	Тур	Max
А	4.4		4.6
В	2.5		2.7
D	2.5		2.75
E	0.45		0.7
F	0.75		1
F1	1.3		1.8
F2	1.3		1.8
G	4.95		5.2
G1	2.4		2.7
Н	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5		3.4	
L6	15.9		16.4
L7	9		9.3
L8	14.5		15
L9		2.4	
L10		0.3	
Dia	3		3.2





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# 5 Revision history

Table 5.	<b>Revision history</b>	
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			- -
	Date	Revision	Changes
	18-Oct-2005	1	First release
	15-Feb-2006	2	New template, complete version with curves
	08-May-2006	3	Typo mistake on table1
	22-May-2006	4	V <sub>(BR)EBO</sub> value has been changed
	22-Sep-2006	5	New h <sub>FE</sub> limit
	11-Jul-2007	6	Updated mechanical data
obsole	steprod		obsolete

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